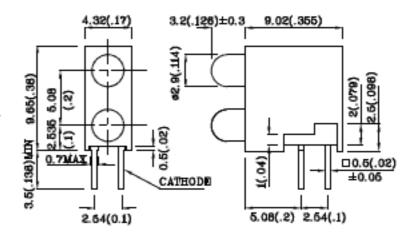


Part Number: XYN2LUY11D

# T-1 (3mm) BI-LEVEL LED INDICATOR

#### Features

- PRE-TRIMMED LIADS FOR PC MOUNTING.
- I.C.COMPATIBLE.
- WIDE VIEWING ANGLE.
- BLACK CASE ENHANCES CONTRAST RATIO.
- HIGH RELIABILITY LIFE MEASURED IN YEARS.
- UL RATING: 94V-0.
- HOUSING MATERIAL: TYPE 66 NYLON.
- RoHS COMPLIANT.



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01^{\circ})$  unless otherwise noted.

Absolute maximum ratings (Ta=25°C)		UY (GaAsP/GaP)	Unit		
Reverse Voltage	VR	15	v		
Forward Current	IF	30	mА		
Forward Current (peak) 1/10Duty Cycle 0.1ms Pulse Width	iFS	140	mА		
Power Dissipation	PŢ	105	шW		
Operating Temperature	TA	-40 ~ +85	ç		
Storage Temperature	Tstg	-40 ~ +85			
Lead Solder Temperature [2mm below package base]	260°C For 3 Seconds				
Lead Solder Temperature [5mm below package base]	260°C For 5 Seconds				

Operating Characterist (T <sub>A</sub> =25°C)	UY (GaAsP/GaP)	Unit	
Forward Voltage (typ.) (TF=10mA)	VF	1.95	v
Forward Voltage (max.) (Tp=10mA)	VF	2.5	v
Reverse Current (VR=5V)	IR	10	ų.
Wavelength of Peak Emission (IF=10mA)	λP	590	nm
Wavelength of Dominant Emission (IF=10mA)	λD	588	nm
Spectral Line Full Width At Half-Maximum (IF=10mA)	Δλ	35	nm
Capacitance (VF=0V, f=1MHz)	С	20	pF

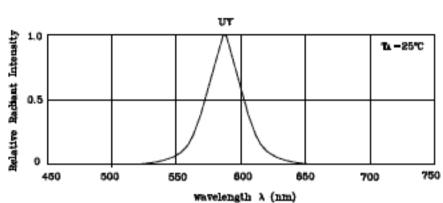
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=10mA) mcd		Wavelength nm λ P	Viewing Angle 2 0 1/2
				min.	typ.		
XYN2LUY11D	Yellow	GaAsP/GaP	Yellow Diffused	5	14	590	40°
Published Date : M	AY 07,2005	Drawin	g No : XDSA7935	V1	Che	cked: B.L.LIU	P.1/3





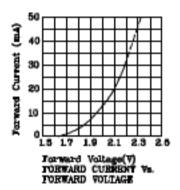
Part Number: XYN2LUY11D

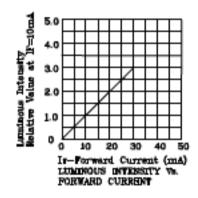
## T-1 (3mm) BI-LEVEL LED INDICATOR

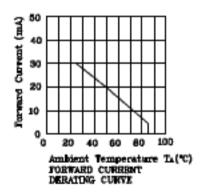


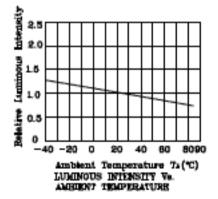
RELATIVE DITENSITY Vs. WAVELENGTH

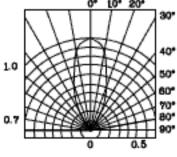
### UY











SPATIAL DESTRIBUTION

Published Date: MAY 07,2005 Drawing No: XDSA7935 V1 Checked: B.L.LIU P.2/3

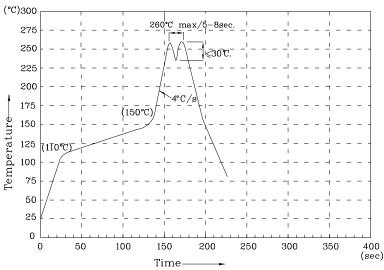


### Part Number: XYN2LUY11D

### T-1 (3mm) BI-LEVEL LED INDICATOR

P.3/3





#### NOTE:

- 1. Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85 degree  ${}^{\circ}\!\text{C}.$
- 3. The soldering profile apply to the lead free soldering ( $\mathrm{Sn}/\mathrm{Cu}/\mathrm{Ag}$  alloy).
- 4. No more than once.

#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.